

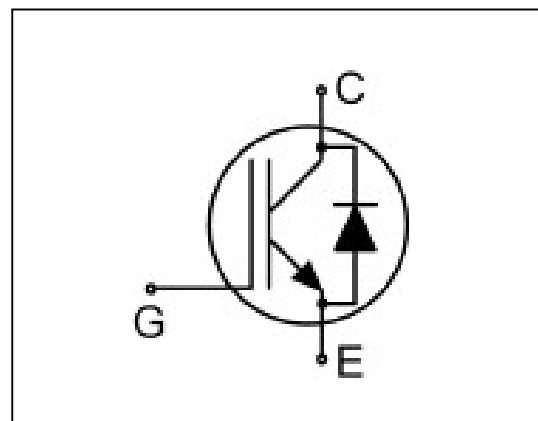
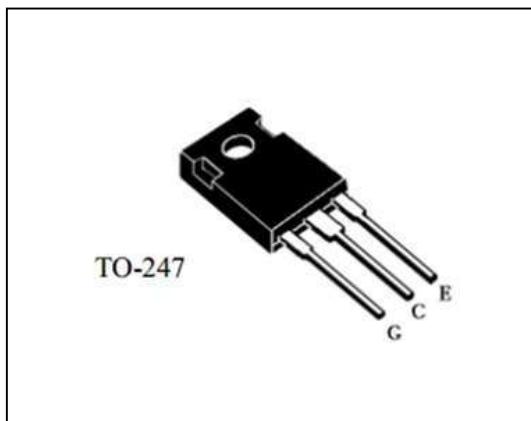
1200V 40A IGBT Discrete

1200V 40A IGBT 单管

General Description / 概述

SOLIDPOWER IGBT Discrete provides low switching losses as well as high RBSOA capability. They are designed for the applications such as industrial UPS, charger, Energy storage, Three-level solar string inverter, welding etc.

索力德普 IGBT 功率单管具有低的开关损耗和良好的 RBSOA 能力。此设计适用于工业 UPS，充电桩，储能，光伏逆变器，焊机等应用。



Features:

- 1200V Trench Field Stop technology
- SiC SBD Freewheeling Diodes
- Low switching losses
- Low gate charge

Typical Applications:

- Industrial UPS
- Charger
- Energy storage
- Inverter
- Welding

产品特性:

- 1200V 沟槽栅+场截止技术
- SiC SBD 续流二极管
- 低开关损耗
- 低栅极电荷

典型应用:

- 工业UPS
- 充电桩
- 储能
- 逆变器
- 焊机

IGBT / IGBT

Maximum Rated Values / 最大额定值

Item	Symbol	Conditions	Value	Units
集电极-发射极电压 Collector-emitter voltage	V_{CES}	$T_{vj}=25^{\circ}\text{C}$	1200	V
连续集电极直流电流 Continuous DC collector current	$I_{C\text{nom}}$	$T_C=25^{\circ}\text{C}, T_{vj}=175^{\circ}\text{C}$ $T_C=100^{\circ}\text{C}, T_{vj}=175^{\circ}\text{C}$	80 40	A
最大脉冲集电极电流 Collector Current – pulse	I_{CM}		160	A
总功率损耗 Total power dissipation	P_{tot}	$T_C=25^{\circ}\text{C}, T_{vj}=175^{\circ}\text{C}$	568	W
栅极-发射极峰值电压 Maximum gate-emitter voltage	V_{GES}		± 20	V

Characteristic Values / 特征值

Item	Symbol	Conditions	Min.	Typ.	Max.	Units
集电极-发射极饱和电压 Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C=40\text{A}, V_{GE}=15\text{V}$ $T_{vj}=25^{\circ}\text{C}$ $T_{vj}=175^{\circ}\text{C}$	- -	1.8 2.4	2.2 -	V V
栅极阈值电压 Gate threshold voltage	$V_{GE(th)}$	$I_C=0.25\text{mA}, V_{CE}=V_{GE}, T_{vj}=25^{\circ}\text{C}$	4.5	-	6.5	V
栅极电荷 Total gate charge	Q_G	$V_{CC}=960\text{V}, I_C=40\text{A}, V_{GE}=15\text{V}, T_{vj}=25^{\circ}\text{C}$		165		nC
栅极-发射极电荷 Gate to emitter charge	Q_{GE}	$V_{CC}=960\text{V}, I_C=40\text{A}, V_{GE}=15\text{V}, T_{vj}=25^{\circ}\text{C}$		46		nC
栅极-集电极电荷 Gate to collector charge	Q_{GC}	$V_{CC}=960\text{V}, I_C=40\text{A}, V_{GE}=15\text{V}, T_{vj}=25^{\circ}\text{C}$		69		nC
内部栅极电阻 Internal gate resistor	R_{Gint}	$T_{vj}=25^{\circ}\text{C}$		3.4		Ω
输入电容 Input capacitance	C_{ies}	$f=1\text{MHz}, T_{vj}=25^{\circ}\text{C}, V_{CE}=25\text{V}, V_{GE}=0\text{V}$		4604		pF
输出电容 Output capacitance	C_{oes}	$f=1\text{MHz}, T_{vj}=25^{\circ}\text{C}, V_{CE}=25\text{V}, V_{GE}=0\text{V}$		200		pF
反向传输电容 Reverse transfer capacitance	C_{res}	$f=1\text{MHz}, T_{vj}=25^{\circ}\text{C}, V_{CE}=25\text{V}, V_{GE}=0\text{V}$		49		pF
集电极-发射极截止电流 Collector-emitter cut-off current	I_{CES}	$V_{CE}=1200\text{V}, V_{GE}=0\text{V}, T_{vj}=25^{\circ}\text{C}$			0.20	mA
栅极-发射极漏电流 Gate-emitter leakage current	I_{GES}	$V_{CE}=0\text{V}, V_{GE}=20\text{V}, T_{vj}=25^{\circ}\text{C}$			200	nA
开通延迟时间(电感负载) Turn-on delay time, inductive load	$t_{d(on)}$		$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=175^{\circ}\text{C}$	56 50		ns ns
上升时间(电感负载) Rise time, inductive load	t_r		$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=175^{\circ}\text{C}$	98 98		ns ns
关断延迟时间(电感负载) Turn-off delay time, inductive load	$t_{d(off)}$	$I_C=40\text{A}, V_{CE}=600\text{V}$ $V_{GE}=\pm 15\text{V}$ $R_{Gon}=12\Omega$	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=175^{\circ}\text{C}$	208 252		ns ns
下降时间(电感负载) Fall time, inductive load	t_f	$R_{Goff}=12\Omega$ Inductive Load	$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=175^{\circ}\text{C}$	176 322		ns ns
开通损耗能量(每脉冲) Turn-on energy loss per pulse	E_{on}		$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=175^{\circ}\text{C}$	2.10 2.24		mJ mJ
关断损耗能量(每脉冲) Turn-off energy loss per pulse	E_{off}		$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=175^{\circ}\text{C}$	2.28 3.48		mJ mJ
结-外壳热阻 Thermal resistance, junction to case	R_{thjc}	Per IGBT / 每个 IGBT		-	0.25	K/W
工作温度 Temperature under switching conditions	T_{vjop}			-55	150	$^{\circ}\text{C}$

Diode / 二极管

Maximum Rated Values / 最大额定值

Item	Symbol	Conditions	Value	Units
反向重复峰值电压 Peak repetitive reverse voltage	V_{RRM}	$T_{vj}=25^{\circ}\text{C}$	1200	V
连续正向直流电流 Continuous DC forward current	I_F	$T_C=150^{\circ}\text{C}, T_{vj}=175^{\circ}\text{C}$	20	A
二极管正向不重复峰值电流 (浪涌电流) Surge non repetitive forward current	I_{FRM}	$t_p=10\text{ ms}$	160	A

Characteristic Values / 特征值

Item	Symbol	Conditions	Min.	Typ.	Max.	Units
正向电压 Forward voltage	V_F	$I_F=20\text{A}$		$T_{vj}=25^{\circ}\text{C}$ $T_{vj}=175^{\circ}\text{C}$	1.5 1.8 2.1 2.4	V V
结-外壳热阻 Thermal resistance, junction to case	R_{thJC}	Per diode / 每个二极管			0.55	K/W
工作温度 Temperature under switching conditions	T_{vjop}		-40		150	$^{\circ}\text{C}$

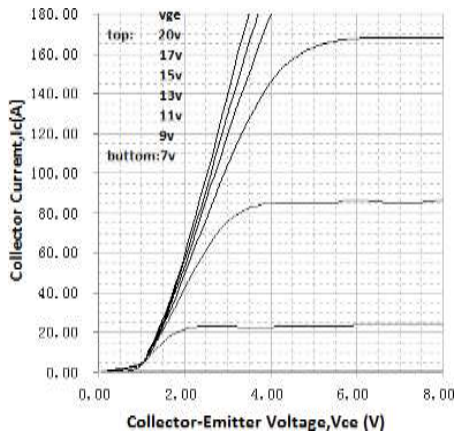
Discrete / 单管

Item	Symbol	Conditions	Min.	Typ.	Max.	Units
储存温度 Storage temperature	T_{stg}		-55		150	°C
引线最高焊接温度 Maximum Lead Temperature for Soldering Purposes	T_L				300	°C

输出特性 IGBT

Output characteristic IGBT

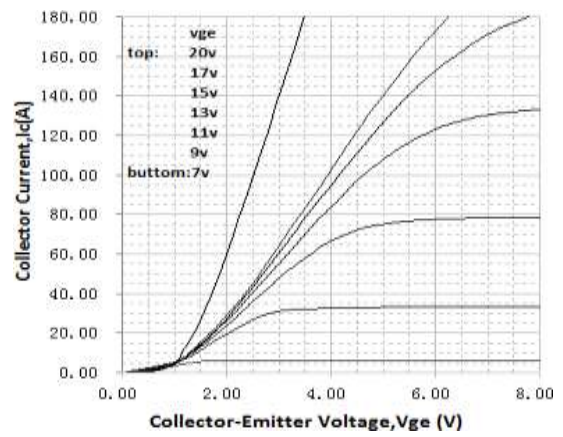
$I_C=f(V_{CE})$, $T_{vj}=25^{\circ}\text{C}$



输出特性 IGBT

Output characteristic IGBT

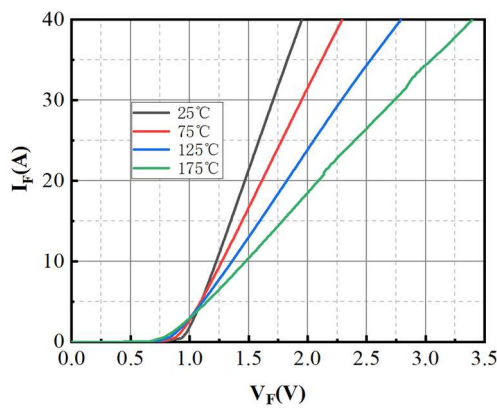
$I_C=f(V_{CE})$, $T_{vj}=175^{\circ}\text{C}$



输出特性 FRD

Output characteristic FRD

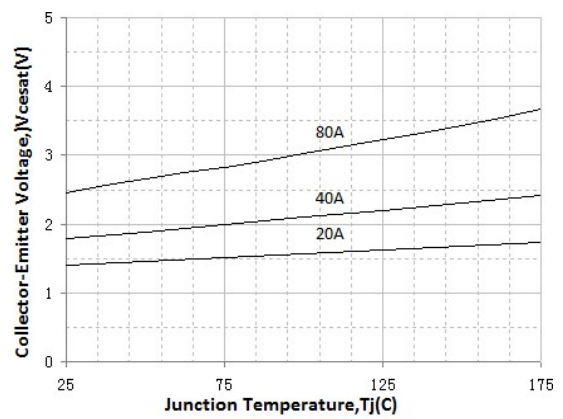
$I_F=f(V_F)$



通态压降 IGBT

Collector-emitter saturation voltage IGBT

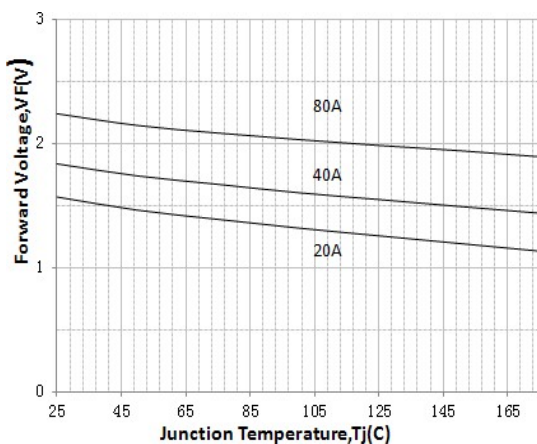
$V_{CE(sat)}=f(T_j)$



正向压降 FRD

Collector-emitter saturation voltage FRD

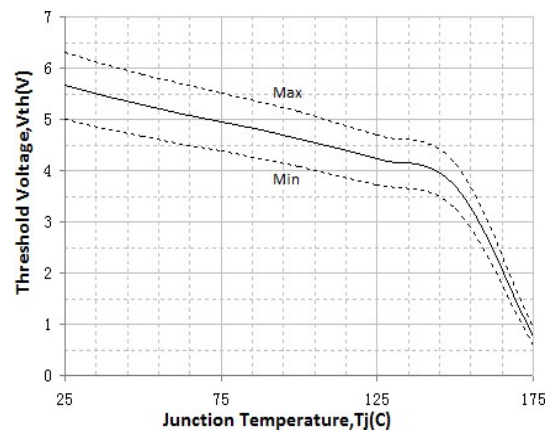
$V_F=f(T_j)$

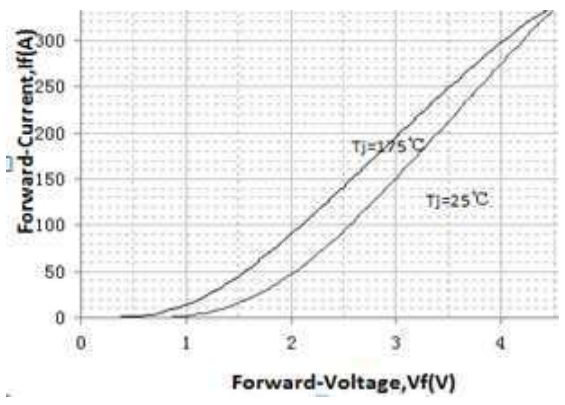
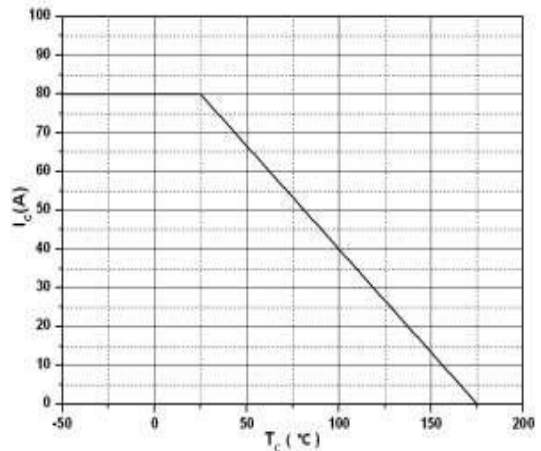
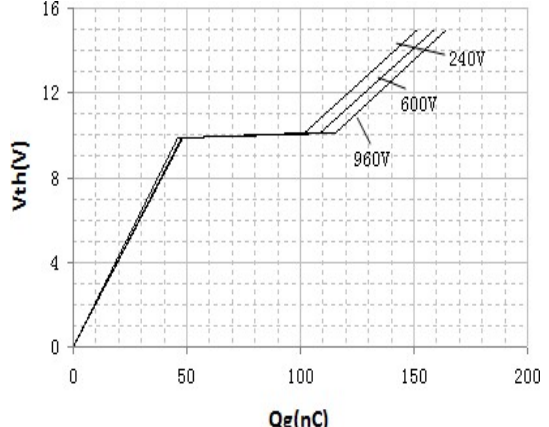
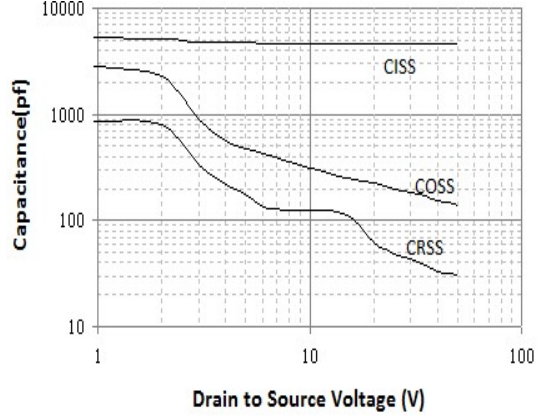
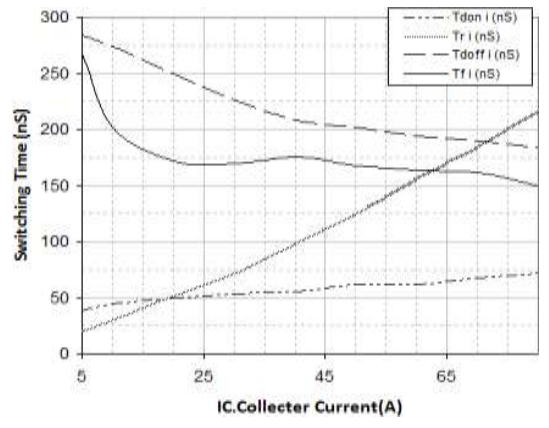
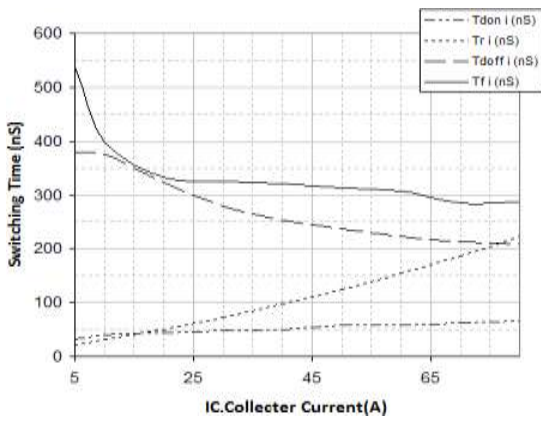


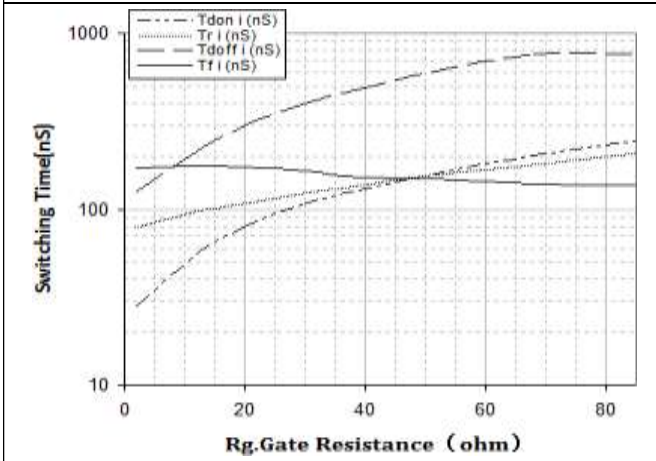
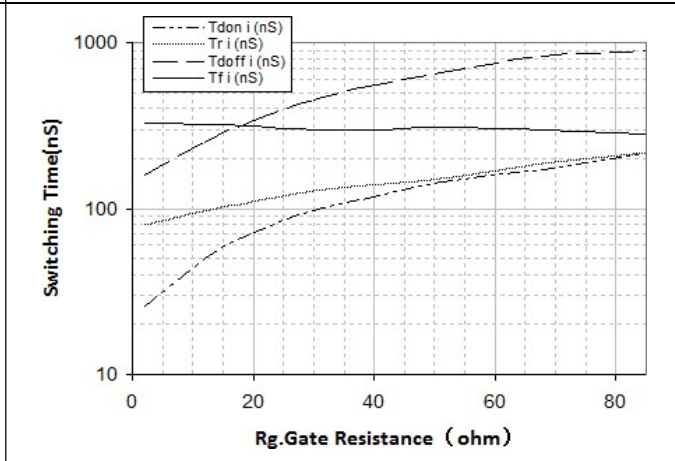
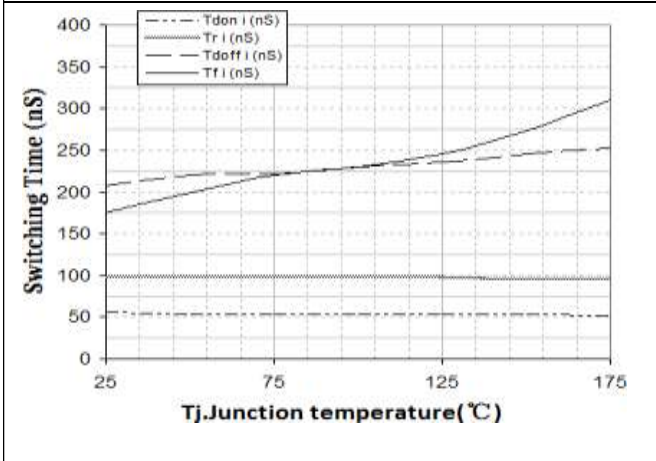
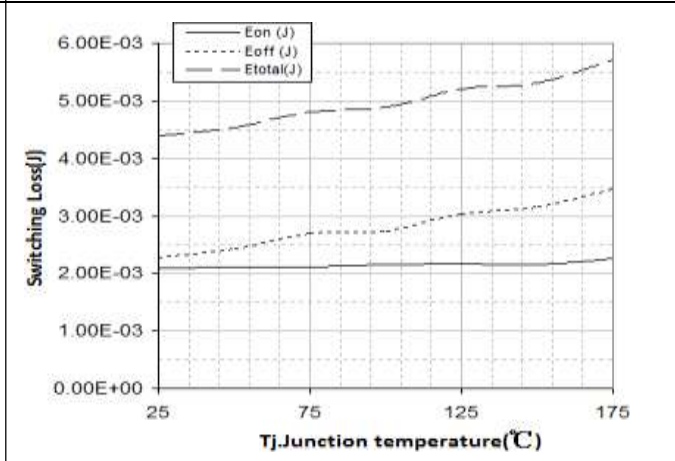
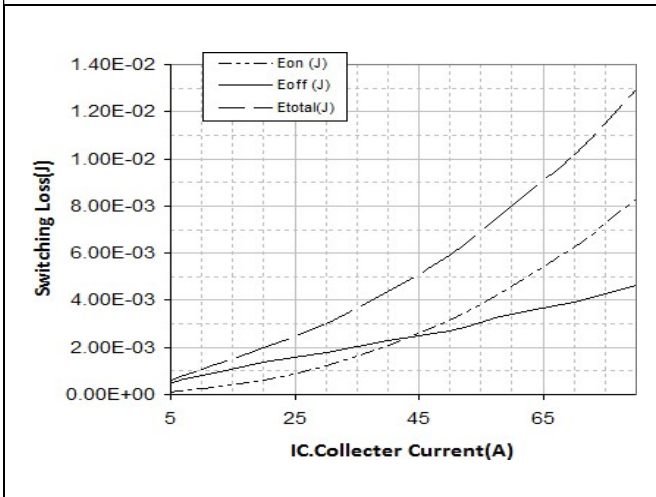
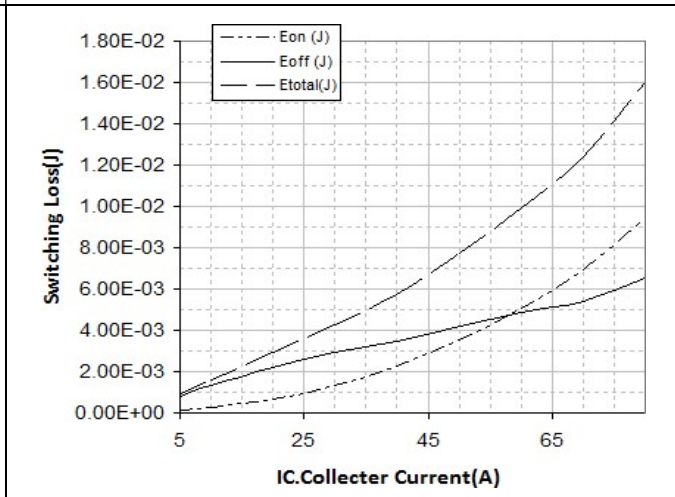
栅极阈值电压 IGBT

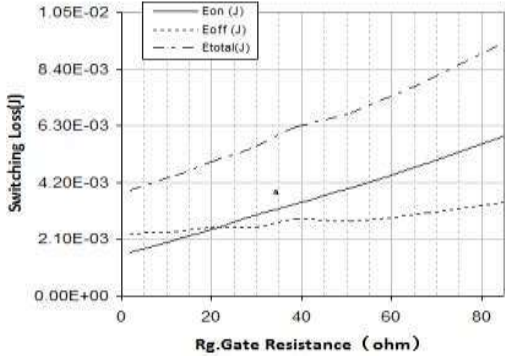
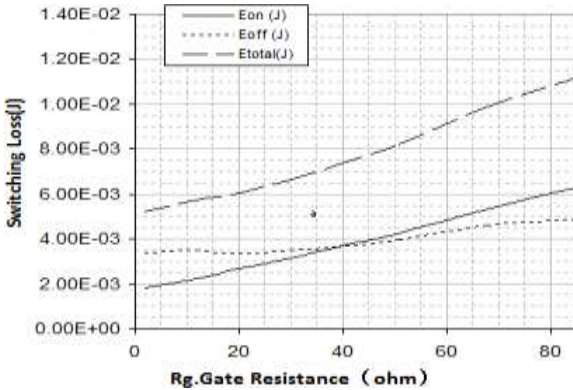
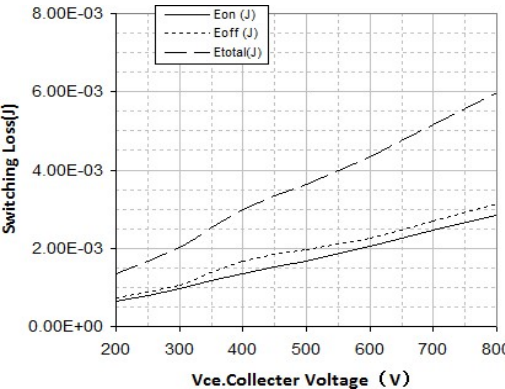
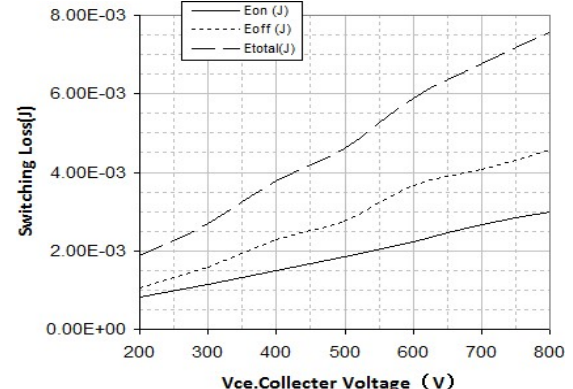
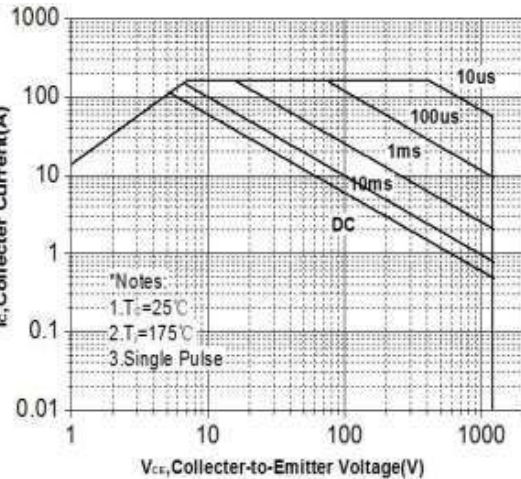
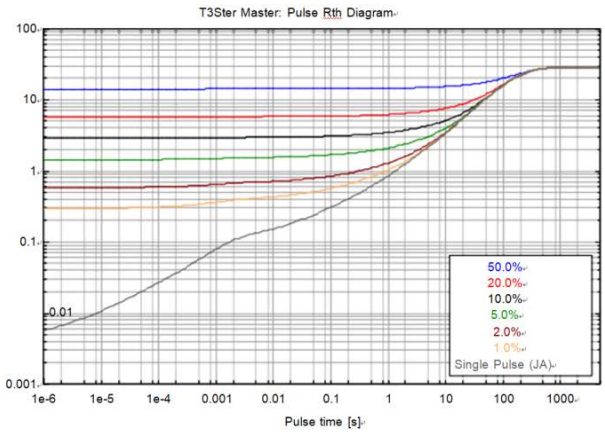
Gate-emitter threshold voltage IGBT

$V_{GE(th)}=f(T_j)$

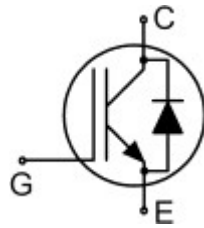


<p>输出特性 FRD Output characteristic FRD $I_F=f(V_F)$</p>	<p>集电极电流 IGBT Collector Current IGBT $I_C=f(T_C)$ $V_{GE} \geq 15V, T_{vj} \leq 175^\circ C$</p>
 <p>Graph showing Forward Current I_F (A) vs Forward Voltage V_F (V). Two curves are shown for $T_J = 175^\circ C$ and $T_J = 25^\circ C$. The current increases with voltage, with the $175^\circ C$ curve being higher than the $25^\circ C$ curve.</p>	 <p>Graph showing Collector Current I_C (A) vs Collector Temperature T_C ($^\circ C$). The current is constant at approximately 80A up to $25^\circ C$ and then decreases linearly to 0A at $175^\circ C$.</p>
<p>栅极电荷 Gate Charge Characteristics $V_{GE(th)} = f(Q_g)$ $V_{GE} = 15V, I_C = 40A$</p>	<p>电容特性 Capacitance Characteristic $V_{CE} = 25V, V_{GE} = 0V, f = 1MHz$</p>
 <p>Graph showing V_{th} (V) vs Q_g (nC). Three curves are shown for $V_{CE} = 240V, 600V, 960V$. The curves show a linear increase in V_{th} with Q_g up to about 50nC, followed by a plateau and then a final linear increase.</p>	 <p>Graph showing Capacitance (pf) vs Drain to Source Voltage (V) on a log-log scale. Three curves are shown for $C_{ISS}, C_{OSS}, C_{RSS}$. C_{ISS} is constant at ~5000pf, C_{OSS} decreases from ~1000pf to ~100pf, and C_{RSS} decreases from ~100pf to ~10pf.</p>
<p>开关时间 IGBT Switching Time IGBT $t_s = f(I_C), T_{vj} = 25^\circ C$</p>	<p>开关时间 IGBT Switching Time IGBT $t_s = f(I_C), T_{vj} = 175^\circ C$</p>
 <p>Graph showing Switching Time (ns) vs I_C Collector Current (A) at $T_{vj} = 25^\circ C$. Curves for $T_{don}(ns), T_r(ns), T_{doff}(ns), T_f(ns)$ are shown. T_{doff} and T_f increase with I_C, while T_{don} and T_r decrease.</p>	 <p>Graph showing Switching Time (ns) vs I_C Collector Current (A) at $T_{vj} = 175^\circ C$. Curves for $T_{don}(ns), T_r(ns), T_{doff}(ns), T_f(ns)$ are shown. T_{doff} and T_f increase with I_C, while T_{don} and T_r decrease.</p>

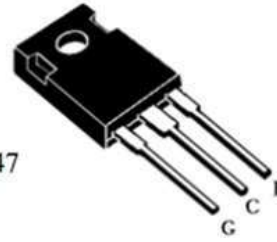
<p>开关时间 IGBT Switching Time IGBT $t_s=f(R_G)$, $T_{vj}=25^\circ\text{C}$ $V_{GE}=15\text{V}$, $V_{CE}=600\text{V}$, $I_C=40\text{A}$</p>	<p>开关时间 IGBT Switching Time IGBT $t_s=f(R_G)$, $T_{vj}=175^\circ\text{C}$ $V_{GE}=15\text{V}$, $V_{CE}=600\text{V}$, $I_C=40\text{A}$</p>
	
<p>开关时间 IGBT Switching Time IGBT $t_s=f(T_j)$ $V_{GE}=15\text{V}$, $V_{CE}=600\text{V}$, $R_G=12\Omega$, $I_C=40\text{A}$</p>	<p>开关损耗 IGBT Switching losses IGBT $E=f(T_j)$ $V_{GE}=15\text{V}$, $V_{CE}=600\text{V}$, $R_G=12\Omega$, $I_C=40\text{A}$</p>
	
<p>开关损耗 IGBT Switching losses IGBT $E=f(I_C)$ $V_{GE}=15\text{V}$, $V_{CE}=600\text{V}$, $R_G=12\Omega$, $T_{vj}=25^\circ\text{C}$</p>	<p>开关损耗 IGBT Switching losses IGBT $E=f(I_C)$ $V_{GE}=15\text{V}$, $V_{CE}=600\text{V}$, $R_G=12\Omega$, $T_{vj}=175^\circ\text{C}$</p>
	

<p>开关损耗 IGBT Switching losses IGBT $E=f(R_G)$ $V_{GE}=15V, V_{CE}=600V, I_C=40A, T_{vj}=25^\circ C$</p>	<p>开关损耗 IGBT Switching losses IGBT $E=f(R_G)$ $V_{GE}=15V, V_{CE}=600V, I_C=40A, T_{vj}=175^\circ C$</p>
	
<p>开关损耗 IGBT Switching losses IGBT $E=f(V_{CE}), T_{vj}=25^\circ C$ $V_{GE}=15V, R_G=12\Omega, I_C=40A$</p>	<p>开关损耗 IGBT Switching losses IGBT $E=f(V_{CE}), T_{vj}=175^\circ C$ $V_{GE}=15V, R_G=12\Omega, I_C=40A$</p>
	
<p>正向安全工作区 Forward Bias SOA $T_C=25^\circ C, V_{GE}=15V, T_{vj}\leq 175^\circ C$</p>	<p>瞬态热阻抗 IGBT Transient thermal impedance IGBT $Z_{thJA}=f(t)$</p>
	

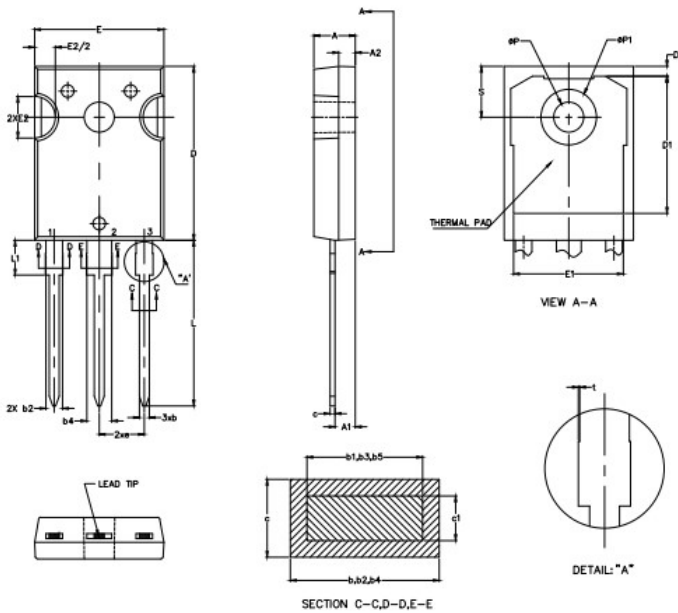
Circuit diagram headline / 接线图



TO-247



Package outlines / 封装尺寸



DIMENSIONS	DIMENSIONS			
	mm		inch	
	MIN.	MAX.	MIN.	MAX.
A	4.90	5.10	0.193	0.201
A1	2.31	2.51	0.091	0.099
A2	1.90	2.10	0.075	0.083
b	1.16	1.26	0.046	0.050
b1	1.15	1.22	0.045	0.048
b2	1.96	2.06	0.077	0.081
b3	1.95	2.02	0.077	0.080
b4	2.96	3.06	0.117	0.120
b5	2.95	3.02	0.116	0.119
c	0.59	0.66	0.023	0.026
c1	0.58	0.62	0.023	0.024
D	20.90	21.10	0.823	0.831
D1	16.25	16.85	0.640	0.663
D2	1.05	1.35	0.041	0.053
E	15.75	15.90	0.620	0.626
E1	13.26	—	0.552	—
E2	4.90	5.10	0.193	0.201
e	5.44BSC		0.214BSC	
L	19.80	20.10	0.780	0.791
L1	—	4.30	—	0.169
øP	3.50	3.70	0.138	0.146
øP1	—	7.40	—	0.291
S	6.05	6.25	0.238	0.246
t	0.00	0.15	0.000	0.006